MOSFETs Silicon N-channel MOS (U-MOSVII-H)

# **XPH6R30ANB**

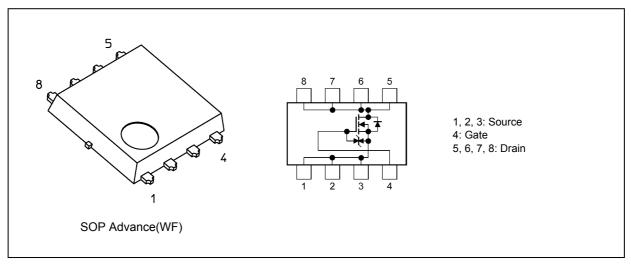
### 1. Applications

- Automotive
- Motor Drivers
- Switching Voltage Regulators

### 2. Features

- (1) AEC-Q101 qualified
- (2) Small, thin package
- (3) Low drain-source on-resistance:  $R_{DS(ON)} = 5.3 \text{ m}\Omega$  (typ.) (V<sub>GS</sub> = 10 V)
- (4) Low leakage current:  $I_{\rm DSS}$  = 10  $\mu A$  (max) (V\_{\rm DS} = 100 V)
- (5) Enhancement mode:  $V_{th}$  = 2.5 to 3.5 V ( $V_{DS}$  = 10 V,  $I_D$  = 0.5 mA)

### 3. Packaging and Internal Circuit



### 4. Absolute Maximum Ratings (Note) (Ta = 25 °C unless otherwise specified)

| Characteris                    | Symbol                   | Rating   | Unit             |            |    |
|--------------------------------|--------------------------|----------|------------------|------------|----|
| Drain-source voltage           |                          |          | V <sub>DSS</sub> | 100        | V  |
| Gate-source voltage            |                          |          | V <sub>GSS</sub> | ±20        |    |
| Drain current (DC)             |                          | (Note 1) | Ι <sub>D</sub>   | 45         | Α  |
| Drain current (pulsed)         |                          | (Note 1) | I <sub>DP</sub>  | 135        | ]  |
| Power dissipation              | (T <sub>c</sub> = 25 °C) |          | PD               | 132        | W  |
| Power dissipation              | (t = 10 s)               | (Note 2) | ] [              | 3.0        | 7  |
| Power dissipation              | (t = 10 s)               | (Note 3) | ] [              | 0.96       | 1  |
| Single-pulse avalanche energy  |                          | (Note 4) | E <sub>AS</sub>  | 137        | mJ |
| Single-pulse avalanche current |                          |          | I <sub>AS</sub>  | 45         | Α  |
| Channel temperature            |                          | (Note 5) | T <sub>ch</sub>  | 175        | °C |
| Storage temperature            |                          | (Note 5) | T <sub>stg</sub> | -55 to 175 |    |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 5. Thermal Characteristics

| Characteristics                      | haracteristics Symbol Max |          |                       |      |      |  |  |  |
|--------------------------------------|---------------------------|----------|-----------------------|------|------|--|--|--|
| Channel-to-case thermal impedance    | (T <sub>c</sub> = 25 °C)  |          | Z <sub>th(ch-c)</sub> | 1.13 | °C/W |  |  |  |
| Channel-to-ambient thermal impedance | (t = 10 s)                | (Note 2) | Z <sub>th(ch-a)</sub> | 50   |      |  |  |  |
| Channel-to-ambient thermal impedance | (t = 10 s)                | (Note 3) | Z <sub>th(ch-a)</sub> | 156  |      |  |  |  |

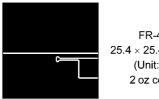
Note 1: Ensure that the channel temperature does not exceed 175 °C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

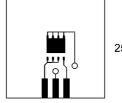
Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4:  $V_{DD}$  = 80 V,  $T_{ch}$  = 25 °C (initial), L = 52.1  $\mu$ H, R<sub>G</sub> = 25  $\Omega$ , I<sub>AS</sub> = 45 A

Note 5: The definitions of the absolute maximum channel and storage temperatures are qualified per AEC-Q101.

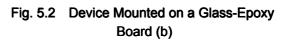


FR-4  $25.4\times25.4\times1.6$ (Unit: mm) 2 oz copper



FR-4  $25.4\times25.4\times1.6$ (Unit: mm) 2 oz copper

Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

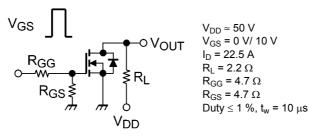
### 6. Electrical Characteristics

### 6.1. Static Characteristics (Ta = 25 °C unless otherwise specified)

| Characteristics                | Symbol               | Test Condition                                  | Min | Тур. | Max | Unit |
|--------------------------------|----------------------|---|-----|------|-----|------|
| Gate leakage current           | I <sub>GSS</sub>     | $V_{GS}$ = ±16 V, $V_{DS}$ = 0 V                | _   |      | ±10 | μA   |
| Drain cut-off current          | I <sub>DSS</sub>     | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V  | _   |      | 10  |      |
| Drain-source breakdown voltage | V <sub>(BR)DSS</sub> | I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V   | 100 |      | _   | V    |
|                                | V <sub>(BR)DSX</sub> | I <sub>D</sub> = 10 mA, V <sub>GS</sub> = -20 V | 80  | _    | _   | ]    |
| Gate threshold voltage         | V <sub>th</sub>      | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.5 mA | 2.5 |      | 3.5 |      |
| Drain-source on-resistance     | R <sub>DS(ON)</sub>  | V <sub>GS</sub> = 6 V, I <sub>D</sub> = 22.5 A  | _   | 6.3  | 9.5 | mΩ   |
|                                |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22.5 A | _   | 5.3  | 6.3 | ]    |

### 6.2. Dynamic Characteristics ( $T_a = 25$ °C unless otherwise specified)

| Characteristics                | Symbol           | Test Condition   | Min | Тур. | Max | Unit |
|--------------------------------|------------------|--|-----|------|-----|------|
| Input capacitance              | C <sub>iss</sub> | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 300 kHz | _   | 3240 | _   | pF   |
| Reverse transfer capacitance   | C <sub>rss</sub> | ]  | _   | 200  | _   |      |
| Output capacitance             | C <sub>oss</sub> | ]  |     | 1270 | _   | pF   |
| Gate resistance                | r <sub>g</sub>   | ]  | _   | 2.0  | 4.0 | Ω    |
| Switching time (rise time)     | tr               | See Fig. 6.2.1   | _   | 16   | _   | ns   |
| Switching time (turn-on time)  | t <sub>on</sub>  | ]  |     | 39   | _   |      |
| Switching time (fall time)     | t <sub>f</sub>   | ]  |     | 16   | _   |      |
| Switching time (turn-off time) | t <sub>off</sub> | ]  |     | 65   | _   | ns   |



#### Fig. 6.2.1 Switching Time Test Circuit

### 6.3. Gate Charge Characteristics ( $T_a = 25$ °C unless otherwise specified)

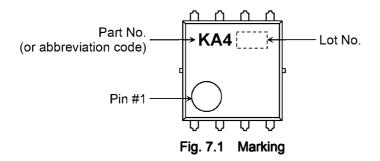
| Characteristics                                 | Symbol           | Test Condition                                       | Min | Тур. | Max | Unit |
|---|------------------|--|-----|------|-----|------|
| Total gate charge (gate-source plus gate-drain) | Qg               | $V_{DD} \approx 80$ V, $V_{GS}$ = 10 V, $I_D$ = 45 A |     | 52   | —   | nC   |
| Gate-source charge 1                            | Q <sub>gs1</sub> |  | _   | 15   | _   |      |
| Gate-drain charge                               | Q <sub>gd</sub>  |  | _   | 11   | _   |      |

### 6.4. Source-Drain Characteristics (T<sub>a</sub> = 25 °C unless otherwise specified)

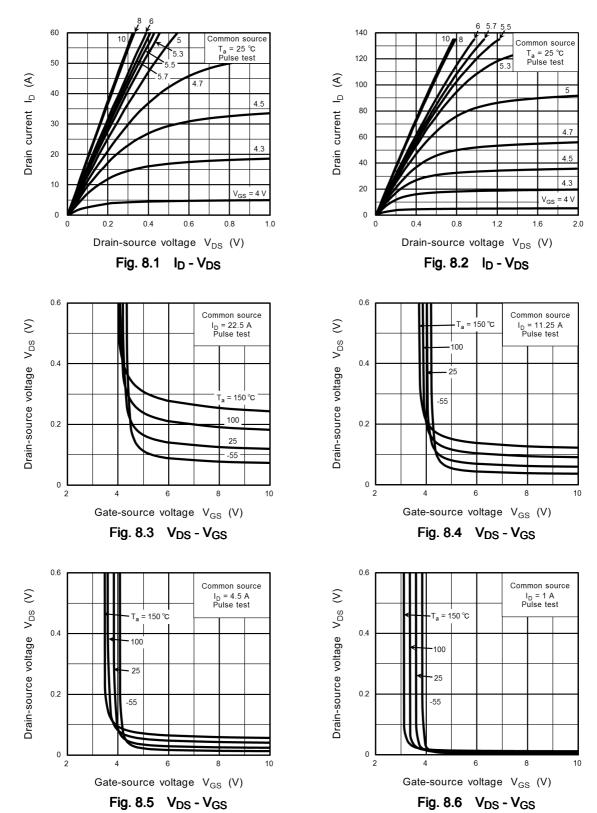
| Characteristics                |          | Symbol           | Test Condition                                | Min | Тур. | Max  | Unit |
|--------------------------------|----------|------------------|---|-----|------|------|------|
| Reverse drain current (pulsed) | (Note 6) | I <sub>DRP</sub> | —   | _   | —    | 135  | А    |
| Diode forward voltage          |          | V <sub>DSF</sub> | I <sub>DR</sub> = 45 A, V <sub>GS</sub> = 0 V |     |      | -1.2 | V    |

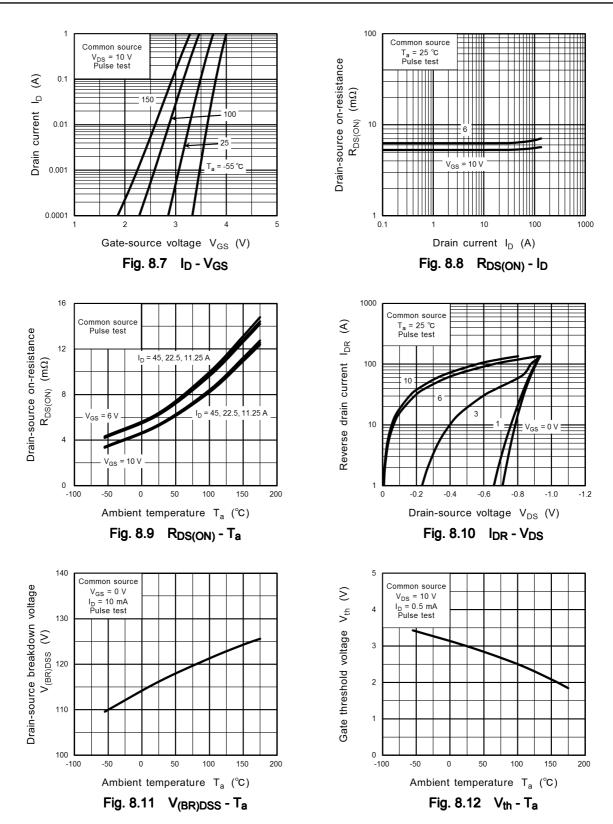
Note 6: Ensure that the channel temperature does not exceed 175 °C.

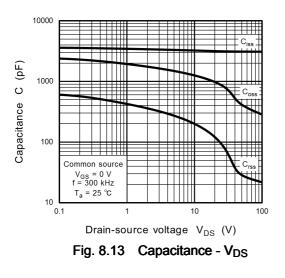
### 7. Marking



### 8. Characteristics Curves (Note)







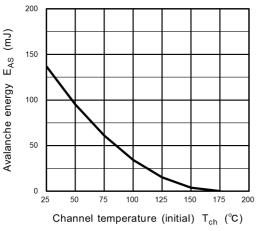


Fig. 8.15 E<sub>AS</sub> - T<sub>ch</sub>(Guaranteed Maximum)

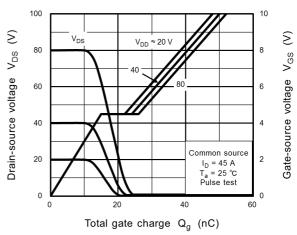


Fig. 8.14 Dynamic Input/Output Characteristics

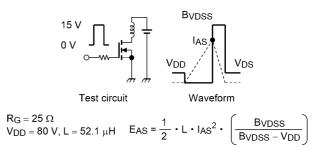


Fig. 8.16 Test Circuit/Waveform

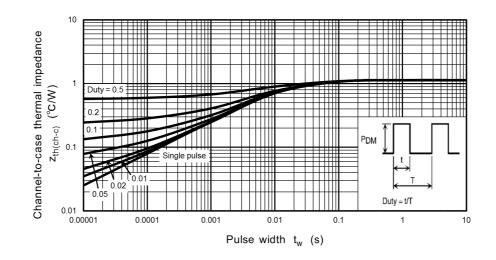
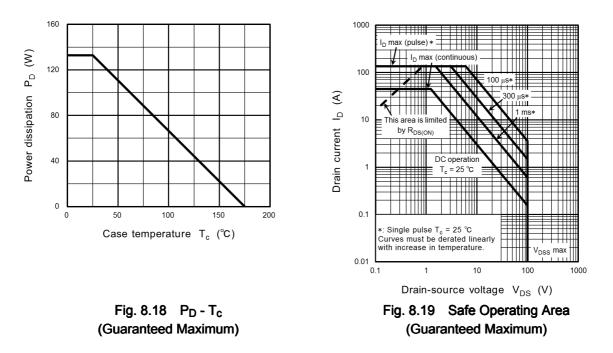


Fig. 8.17  $z_{th(ch-c)} - t_w$ (Guaranteed Maximum)

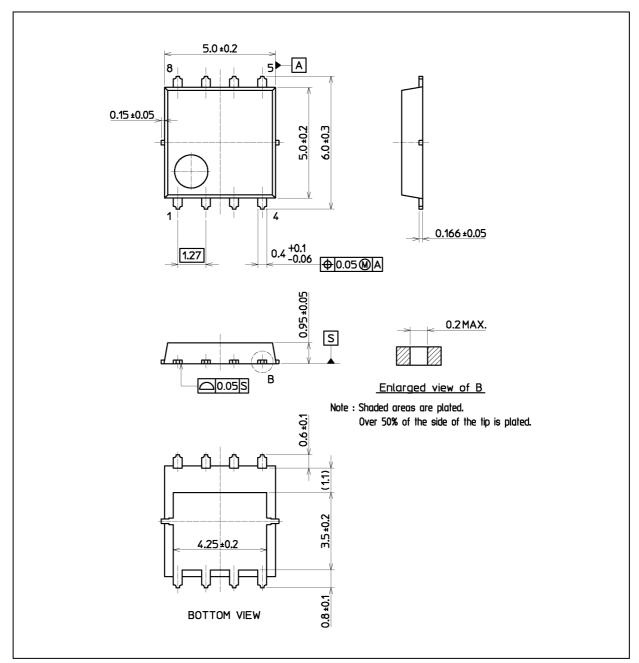


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### XPH6R30ANB

### **Package Dimensions**

Unit: mm



#### Weight: 0.080 g (typ.)

| Package Name(s)           |
|---------------------------|
| TOSHIBA: 2-5Q4A           |
| Nickname: SOP Advance(WF) |

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